Single D-type flip-flop with set and reset; positive edge triggerRev. 12 — 2 April 2013Product data sheet

1. General description

The 74LVC1G74 is a single positive edge triggered D-type flip-flop with individual data (D) inputs, clock (CP) inputs, set (\overline{SD}) and reset (\overline{RD}) inputs, and complementary Q and \overline{Q} outputs.

This device is fully specified for partial power-down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing damaging backflow current through the device when it is powered down.

The set and reset are asynchronous active LOW inputs and operate independently of the clock input. Information on the data input is transferred to the Q output on the LOW-to-HIGH transition of the clock pulse. The D inputs must be stable one set-up time prior to the LOW-to-HIGH clock transition for predictable operation.

Schmitt trigger action at all inputs makes the circuit highly tolerant of slower input rise and fall times.

2. Features and benefits

- Wide supply voltage range from 1.65 V to 5.5 V
- 5 V tolerant inputs for interfacing with 5 V logic
- High noise immunity
- Complies with JEDEC standard:
 - JESD8-7 (1.65 V to 1.95 V)
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8-B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - ◆ HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- ± 24 mA output drive (V_{CC} = 3.0 V)
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Inputs accept voltages up to 5 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



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3. Ordering information

Table 1. Orderin	ng information			
Type number	Package			
	Temperature range	Name	Description	Version
74LVC1G74DP	–40 °C to +125 °C	TSSOP8	plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm	SOT505-2
74LVC1G74DC	–40 °C to +125 °C	VSSOP8	plastic very thin shrink small outline package; 8 leads; body width 2.3 mm	SOT765-1
74LVC1G74GT	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body 1 \times 1.95 \times 0.5 mm	SOT833-1
74LVC1G74GF	–40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.35 \times 1 \times 0.5 mm	SOT1089
74LVC1G74GD	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body $3 \times 2 \times 0.5$ mm	SOT996-2
74LVC1G74GM	–40 °C to +125 °C	XQFN8	plastic, extremely thin quad flat package; no leads; 8 terminals; body $1.6 \times 1.6 \times 0.5$ mm	SOT902-2
74LVC1G74GN	–40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body $1.2 \times 1.0 \times 0.35$ mm	SOT1116
74LVC1G74GS	–40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.35 \times 1.0 \times 0.35 mm	SOT1203

4. Marking

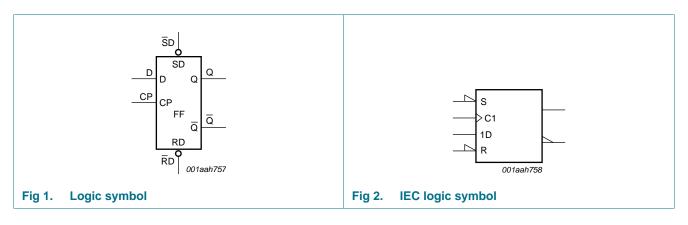
Table 2.Marking codes

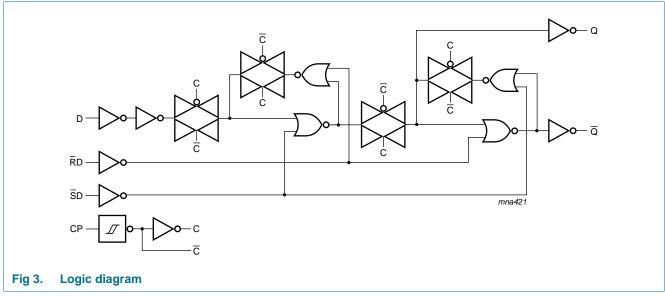
Type number	Marking code ^[1]
74LVC1G74DP	V74
74LVC1G74DC	V74
74LVC1G74GT	V74
74LVC1G74GF	Y4
74LVC1G74GD	V74
74LVC1G74GM	V74
74LVC1G74GN	Y4
74LVC1G74GS	Y4

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

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5. Functional diagram

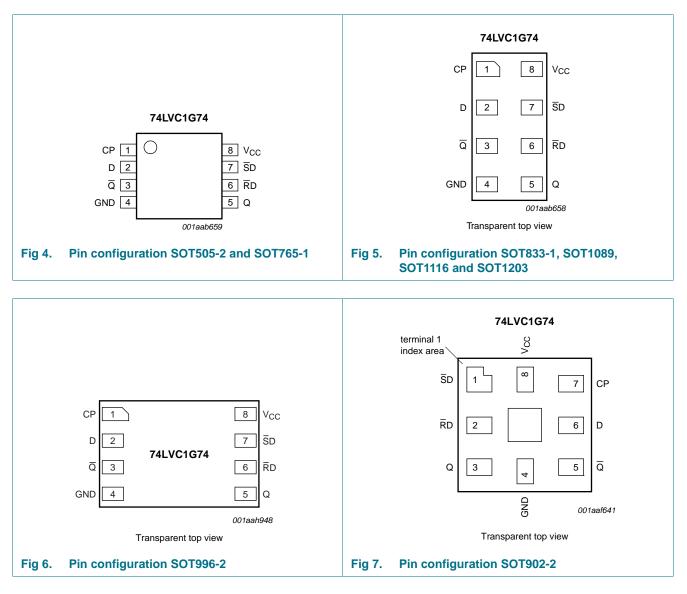




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6. Pinning information

6.1 Pinning



Single D-type flip-flop with set and reset; positive edge trigger

6.2 Pin description

Table 3.	Pin description		
Symbol	Pin	Description	
	SOT505-2, SOT765-1, SOT833-1, SOT1089, SOT996-2, SOT1116 and SOT1203	SOT902-2	
CP	1	7	clock input (LOW-to-HIGH, edge-triggered)
D	2	6	data input
Q	3	5	complement output
GND	4	4	ground (0 V)
Q	5	3	true output
RD	6	2	asynchronous reset-direct input (active LOW)
SD	7	1	asynchronous set-direct input (active LOW)
V _{CC}	8	8	supply voltage

7. Functional description

Table 4. Function table for asynchronous operation^[1]

Input				Output		
SD	RD	СР	D	Q	Q	
L	Н	Х	Х	Н	L	
Н	L	Х	Х	L	Н	
L	L	Х	Х	Н	Н	

[1] H = HIGH voltage level;

L = LOW voltage level;

X = don't care.

Table 5. Function table for synchronous operation^[1]

Input				Output	
SD	RD	СР	D	Q _{n+1}	Q _{n+1}
Н	Н	↑	L	L	Н
Н	Н	\uparrow	Н	Н	L

[1] H = HIGH voltage level;

L = LOW voltage level;

 \uparrow = LOW-to-HIGH CP transition;

 Q_{n+1} = state after the next LOW-to-HIGH CP transition.

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8. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

					,
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V ₁ < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I _{OK}	output clamping current	$V_{O} > V_{CC}$ or $V_{O} < 0 V$	-	±50	mA
Vo	output voltage	Active mode	<u>[1]</u> –0.5	V _{CC} + 0.5	V
		Power-down mode	<u>[1][2]</u> –0.5	+6.5	V
lo	output current	$V_{O} = 0 V$ to V_{CC}	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
P _{tot}	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	<u>[3]</u>	300	mW
T _{stg}	storage temperature		-65	+150	°C

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] When V_{CC} = 0 V (Power-down mode), the output voltage can be 5.5 V in normal operation.

[3] For TSSOP8 packages: above 55 °C the value of P_{tot} derates linearly with 2.5 mW/K.
 For VSSOP8 packages: above 110 °C the value of P_{tot} derates linearly with 8.0 mW/K.
 For XSON8 and XQFN8 packages: above 118 °C the value of P_{tot} derates linearly with 7.8 mW/K.

9. Recommended operating conditions

Table 7.	Operating conditions				
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		1.65	5.5	V
VI	input voltage		0	5.5	V
Vo	output voltage	Active mode	0	V _{CC}	V
		Power-down mode; $V_{CC} = 0 V$	0	5.5	V
T _{amb}	ambient temperature		-40	+125	°C
Δt/ΔV	input transition rise and fall rate	V_{CC} = 1.65 V to 2.7 V	-	20	ns/V
		$V_{CC} = 2.7 \text{ V} \text{ to } 5.5 \text{ V}$	-	10	ns/V

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10. Static characteristics

Table 8. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ <mark>[1]</mark>	Max	Unit
T _{amb} = –	40 °C to +85 °C					
VIH	HIGH-level input voltage	V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	V
		V_{CC} = 2.3 V to 2.7 V	1.7	-	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	V
		V_{CC} = 4.5 V to 5.5 V	$0.7\times V_{CC}$	-	-	V
V _{IL}	LOW-level input voltage	$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	-	-	$0.35\times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.8	V
		V_{CC} = 4.5 V to 5.5 V	-	-	$0.3\times V_{CC}$	V
V _{OH}	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		I_{O} = $-100~\mu\text{A};~V_{CC}$ = 1.65 V to 5.5 V	$V_{CC}-0.1$	-	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	1.54	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.9	2.15	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	2.50	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.3	2.62	-	V
		$I_O = -32$ mA; $V_{CC} = 4.5$ V	3.8	4.11	-	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		I_O = 100 $\mu\text{A};V_{CC}$ = 1.65 V to 5.5 V	-	-	0.10	V
		$I_{O} = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	0.07	0.45	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	0.12	0.30	V
		$I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	0.17	0.40	V
		$I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	0.33	0.55	V
		$I_{O} = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.39	0.55	V
lı	input leakage current	V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V	-	±0.1	±5	μA
OFF	power-off leakage current	$V_{I} \text{ or } V_{O} = 5.5 \text{ V}; V_{CC} = 0 \text{ V}$	-	±0.1	±10	μA
СС	supply current	$V_{I} = 5.5 V \text{ or GND};$ $V_{CC} = 1.65 V \text{ to } 5.5 V; I_{O} = 0 \text{ A}$	-	0.1	10	μA
∆I _{CC}	additional supply current	per pin; V _I = V _{CC} – 0.6 V; I _O = 0 A; V _{CC} = 2.3 V to 5.5 V	-	5	500	μA
C _I	input capacitance		-	4.0	-	pF

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Single D-type flip-flop with set and reset; positive edge trigger

At recommended operating conditions; voltages are referenced to GND (ground = 0 V). Symbol Parameter Conditions Typ^[1] Max Unit Min T_{amb} = -40 °C to +125 °C $V_{CC} = 1.65 \text{ V}$ to 1.95 V V HIGH-level input voltage $0.65 \times V_{CC}$ -VIH - $V_{CC} = 2.3 \text{ V}$ to 2.7 V 1.7 -V - $V_{CC} = 2.7 \text{ V}$ to 3.6 V 2.0 V -- $V_{CC} = 4.5 \text{ V}$ to 5.5 V $0.7 \times V_{CC}$ -V - $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ VIL LOW-level input voltage _ $0.35 \times V_{CC}$ V _ $V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$ 0.7 V -- $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ V 0.8 _ - $V_{CC} = 4.5 \text{ V}$ to 5.5 V $0.3 \times V_{CC}$ V --Vон HIGH-level output voltage $V_I = V_{IH}$ or V_{IL} V $I_{O} = -100 \ \mu\text{A}; \ V_{CC} = 1.65 \ \text{V}$ to 5.5 V $V_{CC} - 0.1$ -- $I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ 0.95 V -- $I_O = -8$ mA; $V_{CC} = 2.3$ V 1.7 -V - $I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ V 1.9 -_ $I_0 = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ 2.0 V -- $I_{O} = -32 \text{ mA}; V_{CC} = 4.5 \text{ V}$ 3.4 V --LOW-level output voltage $V_I = V_{IH}$ or V_{IL} VOL $I_{O} = 100 \ \mu\text{A}; V_{CC} = 1.65 \ \text{V}$ to 5.5 V 0.10 V -- $I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ 0.70 V -- $I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ V 0.45 _ - $I_0 = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ --0.60 V $I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ 0.80 V -- $I_0 = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$ V 0.80 _ _ input leakage current $V_1 = 5.5 \text{ V or GND};$ ±20 I_I -μΑ $V_{CC} = 0 V \text{ to } 5.5 V$ power-off leakage current V_I or V_O = 5.5 V; V_{CC} = 0 V +20μΑ **I**OFF _ - $V_1 = 5.5 \text{ V or GND};$ supply current 40 Icc _ μΑ $V_{CC} = 1.65 \text{ V}$ to 5.5 V; $I_{O} = 0 \text{ A}$ additional supply current per pin; $V_I = V_{CC} - 0.6 V$; $I_O = 0 A$; 5000 μA Δlcc _ V_{CC} = 2.3 V to 5.5 V

Static characteristics ... continued Table 8.

[1] All typical values are measured at $T_{amb} = 25 \text{ °C}$.

Single D-type flip-flop with set and reset; positive edge trigger

11. Dynamic characteristics

Table 9. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 10.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	o +125 ℃	Unit	
				lin	Typ <mark>[1]</mark>	Max	Min	Max		
pd	propagation delay	CP to Q, Q; see Figure 8	2]							
		V_{CC} = 1.65 V to 1.95 V	1	.5	6.0	13.4	1.5	13.4	ns	
		V_{CC} = 2.3 V to 2.7 V	1	.0	3.5	7.1	1.0	7.1	ns	
		$V_{CC} = 2.7 V$	1	.0	3.5	7.1	1.0	7.1	ns	
		V_{CC} = 3.0 V to 3.6 V	1	.0	3.5	5.9	1.0	5.9	ns	
		V_{CC} = 4.5 V to 5.5 V	1	.0	2.5	4.1	1.0	4.1	ns	
		\overline{SD} to Q, \overline{Q} ; see Figure 9	2]							
		V_{CC} = 1.65 V to 1.95 V	1	.5	6.0	12.9	1.5	12.9	ns	
		V_{CC} = 2.3 V to 2.7 V	1	.0	3.5	7.0	1.0	7.0	ns	
		V _{CC} = 2.7 V	1	.0	3.5	7.0	1.0	7.0	ns	
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	1	.0	3.0	5.9	1.0	5.9	ns	
		$V_{CC} = 4.5 V \text{ to } 5.5 V$	1	.0	2.5	4.1	1.0	4.1	ns	
		\overline{RD} to Q, \overline{Q} ; see <u>Figure 9</u>	2]							
		V_{CC} = 1.65 V to 1.95 V	1	.5	5.0	12.9	1.5	12.9	ns	
		V_{CC} = 2.3 V to 2.7 V	1	.0	3.5	7.0	1.0	7.0	ns	
		V _{CC} = 2.7 V	1	.0	3.5	7.0	1.0	7.0	ns	
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	1	.0	3.0	5.9	1.0	5.9	ns	
		$V_{CC} = 4.5 V \text{ to } 5.5 V$	1	.0	2.5	4.1	1.0	4.1	ns	
W	pulse width	CP HIGH or LOW; see Figure 8								
		V _{CC} = 1.65 V to 1.95 V	6	5.2	-	-	6.2	-	ns	
		V_{CC} = 2.3 V to 2.7 V	2	2.7	-	-	2.7	-	ns	
		V _{CC} = 2.7 V	2	2.7	-	-	2.7	-	ns	
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	2	2.7	1.3	-	2.7	-	ns	
		V_{CC} = 4.5 V to 5.5 V	2	2.0	-	-	2.0	-	ns	
		SD and RD LOW; see <u>Figure 9</u>								
		V_{CC} = 1.65 V to 1.95 V	6	5.2	-	-	6.2	-	ns	
		V_{CC} = 2.3 V to 2.7 V	2	2.7	-	-	2.7	-	ns	
		$V_{CC} = 2.7 V$	2	2.7	-	-	2.7	-	ns	
		V_{CC} = 3.0 V to 3.6 V	2	2.7	1.6	-	2.7	-	ns	
		V_{CC} = 4.5 V to 5.5 V	2	2.0	-	-	2.0	-	ns	

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Symbol	Parameter	Conditions	-40) °C to +8	5 °C	-40 °C to	o +125 ℃	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
rec	recovery time	SD or RD; see Figure 9						
		V_{CC} = 1.65 V to 1.95 V	1.9	-	-	1.9	-	ns
		V_{CC} = 2.3 V to 2.7 V	1.4	-	-	1.4	-	ns
		$V_{CC} = 2.7 V$	1.3	-	-	1.3	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	+1.2	-3.0	-	+1.2	-	ns
		V_{CC} = 4.5 V to 5.5 V	1.0	-	-	1.0	-	ns
t _{su} set-up time	set-up time	D to CP; see Figure 8						
		V_{CC} = 1.65 V to 1.95 V	2.9	-	-	2.9	-	ns
		V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	ns
		$V_{CC} = 2.7 V$	1.7	-	-	1.7	-	ns
		V_{CC} = 3.0 V to 3.6 V	1.3	0.5	-	1.3	-	ns
		V_{CC} = 4.5 V to 5.5 V	1.1	-	-	1.1	-	ns
t _h	hold time	D to CP; see Figure 8						
		V_{CC} = 1.65 V to 1.95 V	1.5	-	-	1.5	-	ns
		V_{CC} = 2.3 V to 2.7 V	1.0	-	-	1.0	-	ns
		$V_{CC} = 2.7 V$	1.0	-	-	1.0	-	ns
		V_{CC} = 3.0 V to 3.6 V	1.0	0.6	-	1.0	-	ns
		V_{CC} = 4.5 V to 5.5 V	1.0	-	-	1.0	-	ns
max	maximum	CP; see Figure 8						
	frequency	V_{CC} = 1.65 V to 1.95 V	80	-	-	80	-	MHz
		V_{CC} = 2.3 V to 2.7 V	175	-	-	175	-	MHz
		V _{CC} = 2.7 V	175	-	-	175	-	MHz
		V_{CC} = 3.0 V to 3.6 V	175	280	-	175	-	MHz
		V_{CC} = 4.5 V to 5.5 V	200	-	-	200	-	MHz
C _{PD}	power dissipation capacitance	$V_I = GND$ to V_{CC} ; $V_{CC} = 3.3 V$	<u>[3]</u> _	15	-	-	-	pF

Table 9. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 10.

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.8 V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively.

- [2] t_{pd} is the same as t_{PLH} and t_{PHL} .
- [3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).
 - $\label{eq:PD} \mathsf{P}_{\mathsf{D}} = \mathsf{C}_{\mathsf{P}\mathsf{D}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}{}^2 \times \mathsf{f}_i \times \mathsf{N} + \Sigma(\mathsf{C}_{\mathsf{L}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}{}^2 \times \mathsf{f}_o) \text{ where:}$
 - $f_i = input frequency in MHz;$
 - $f_o = output frequency in MHz;$
 - C_L = output load capacitance in pF;
 - V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

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12. Waveforms

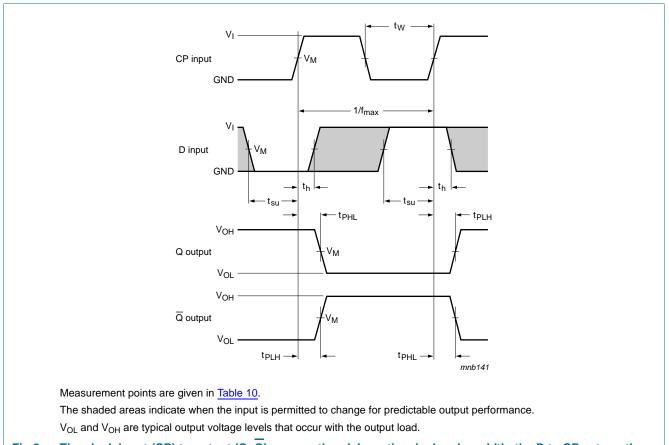


Fig 8. The clock input (CP) to output (Q, Q) propagation delays, the clock pulse width, the D to CP set-up, the CP to D hold times and the maximum frequency

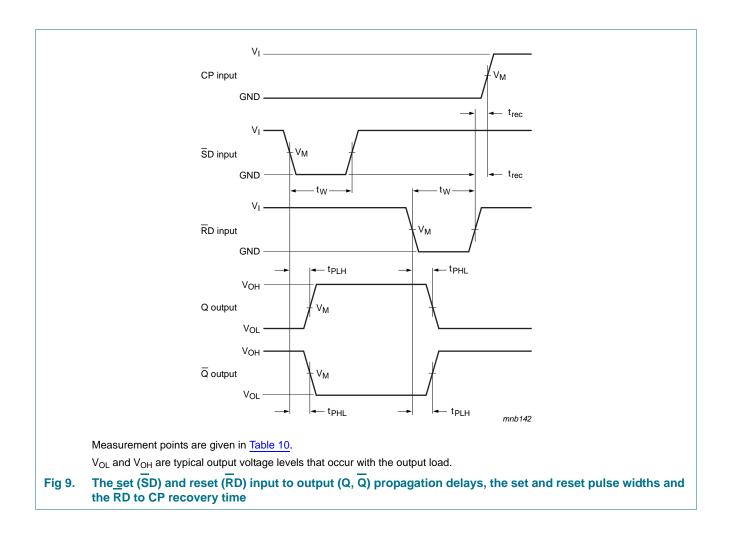
Table 10. Measurement points

Supply voltage	Input	Output	
V _{CC}	V _M	V _M	
1.65 V to 1.95 V	$0.5 imes V_{CC}$	$0.5 imes V_{CC}$	
2.3 V to 2.7 V	$0.5 imes V_{CC}$	$0.5 imes V_{CC}$	
2.7 V	1.5 V	1.5 V	
3.0 V to 3.6 V	1.5 V	1.5 V	
4.5 V to 5.5 V	$0.5 \times V_{CC}$	$0.5 imes V_{CC}$	

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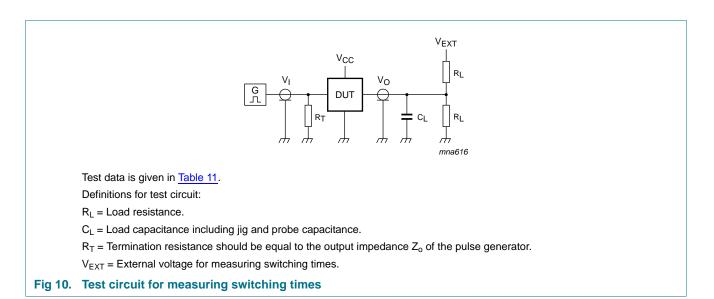


Table 11. Test data

Supply voltage	Input		Load V _{EXT}				Load V _{EXT}		Load		
V _{CC}	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}				
1.65 V to 1.95 V	V _{CC}	\leq 2.0 ns	30 pF	1 kΩ	open	GND	$2V_{CC}$				
2.3 V to 2.7 V	V _{CC}	\leq 2.0 ns	30 pF	500 Ω	open	GND	2V _{CC}				
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	GND	6 V				
3.0 V to 3.6 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	GND	6 V				
4.5 V to 5.5 V	V _{CC}	\leq 2.5 ns	50 pF	500 Ω	open	GND	2V _{CC}				

Single D-type flip-flop with set and reset; positive edge trigger

13. Package outline

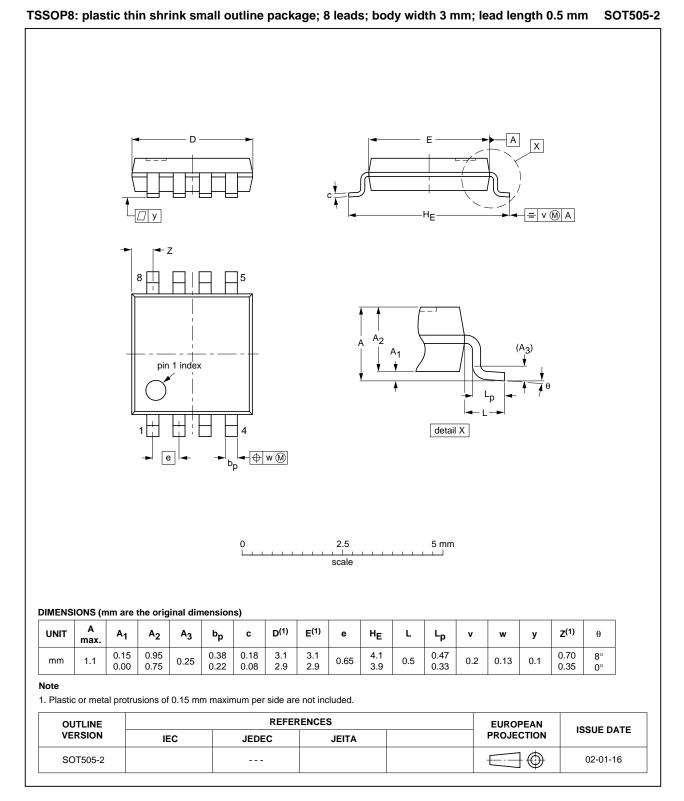


Fig 11. Package outline SOT505-2 (TSSOP8)

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Single D-type flip-flop with set and reset; positive edge trigger

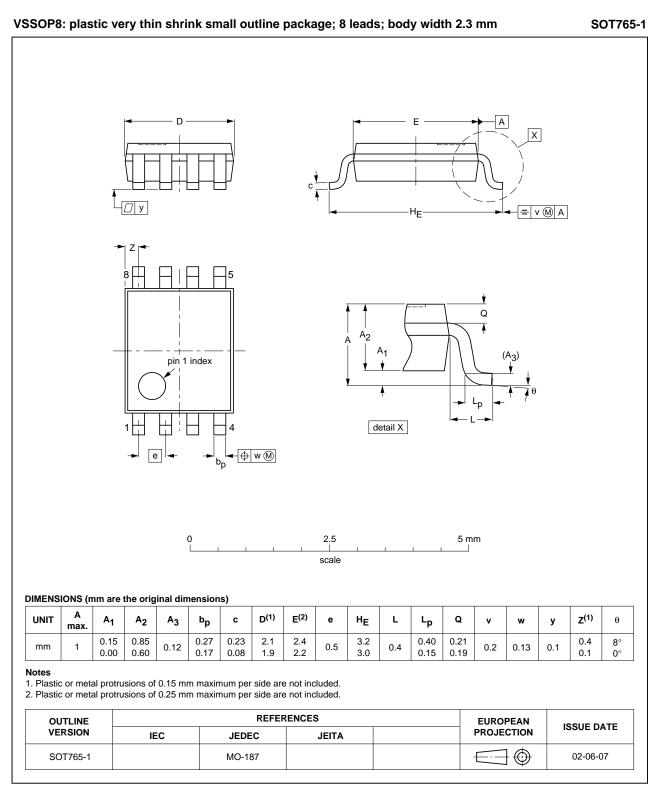


Fig 12. Package outline SOT765-1 (VSSOP8)

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Single D-type flip-flop with set and reset; positive edge trigger

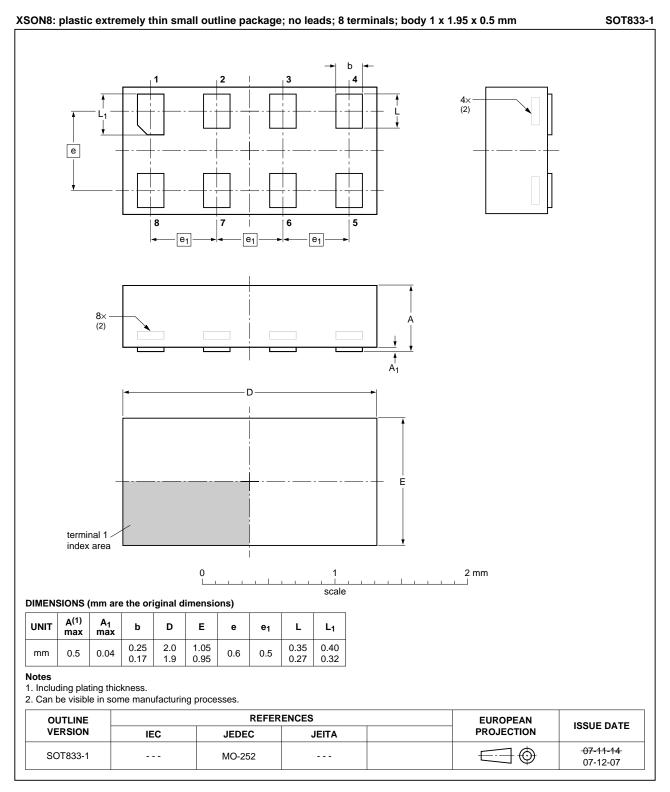
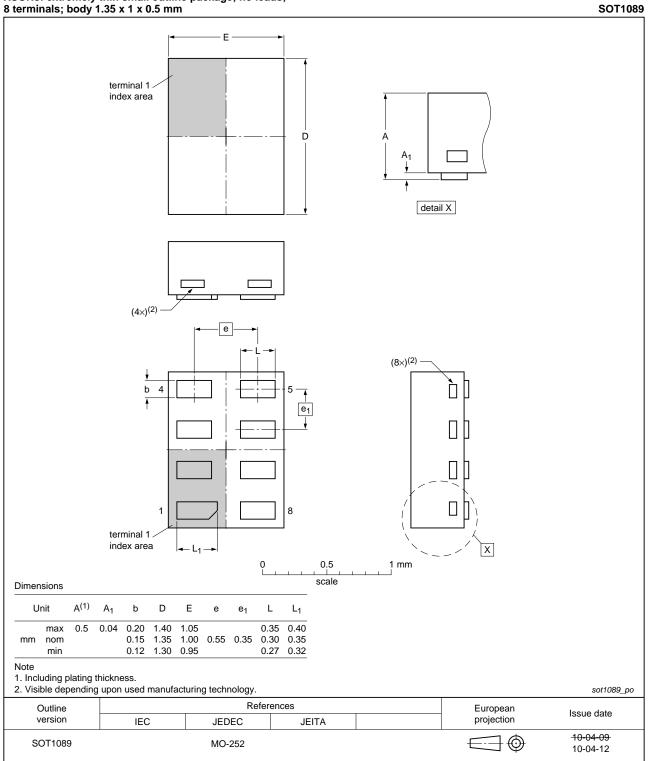


Fig 13. Package outline SOT833-1 (XSON8)

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Single D-type flip-flop with set and reset; positive edge trigger

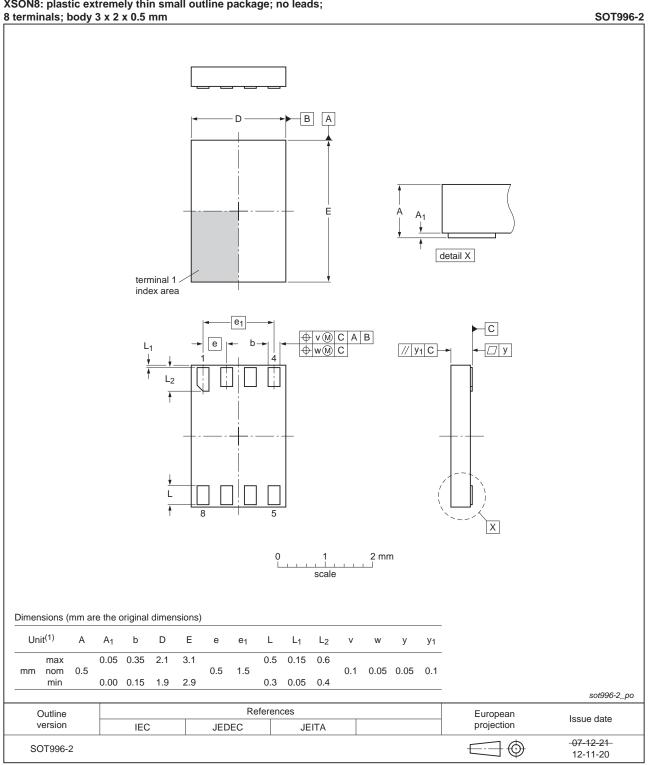


XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.35 x 1 x 0.5 mm

Fig 14. Package outline SOT1089 (XSON8)

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Single D-type flip-flop with set and reset; positive edge trigger

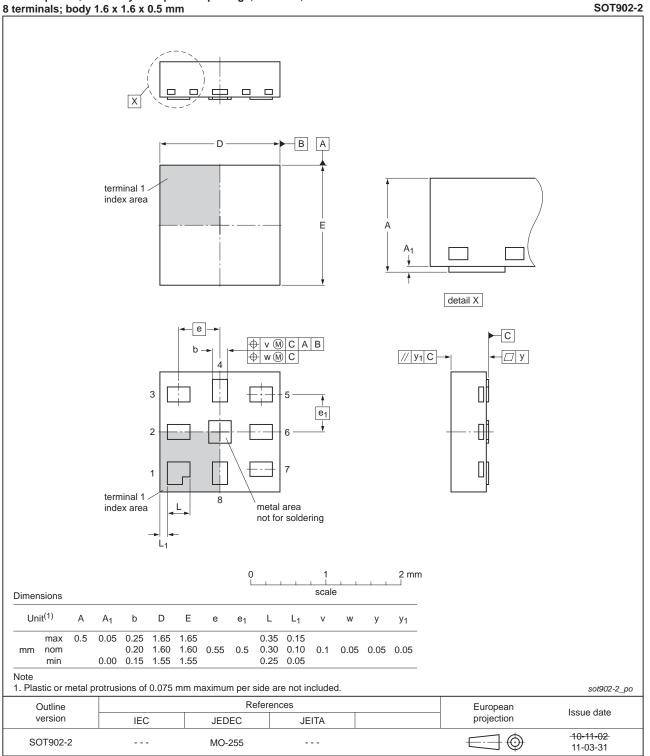


XSON8: plastic extremely thin small outline package; no leads;

Fig 15. Package outline SOT996-2 (XSON8)

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Single D-type flip-flop with set and reset; positive edge trigger

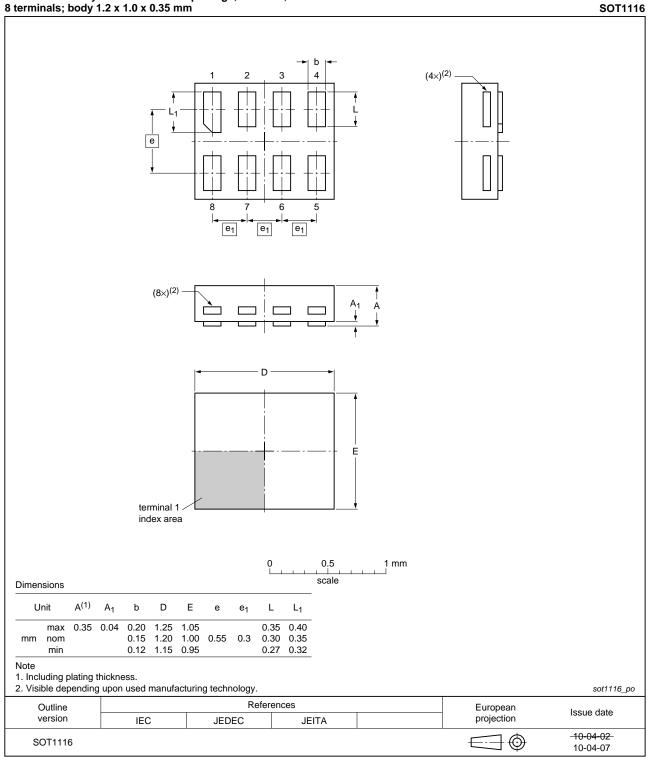


XQFN8: plastic, extremely thin quad flat package; no leads; 8 terminals: body 1.6 x 1.6 x 0.5 mm

Fig 16. Package outline SOT902-2 (XQFN8)

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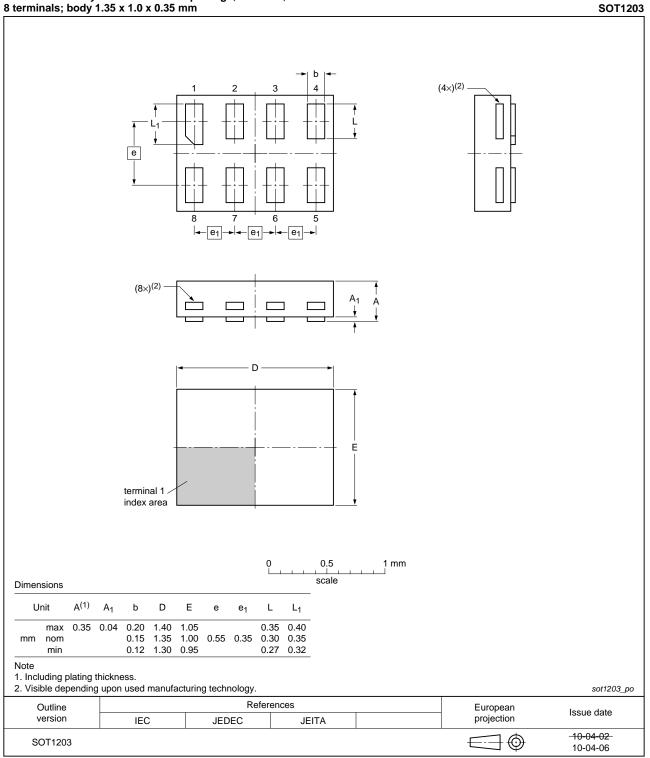
Single D-type flip-flop with set and reset; positive edge trigger



XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.2 x 1.0 x 0.35 mm

Fig 17. Package outline SOT1116 (XSON8)

Single D-type flip-flop with set and reset; positive edge trigger



XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.35 x 1.0 x 0.35 mm

Fig 18. Package outline SOT1203 (XSON8)

Single D-type flip-flop with set and reset; positive edge trigger

14. Abbreviations

Table 12. Abbreviations				
Acronym	Description			
CMOS	Complementary Metal-Oxide Semiconductor			
HBM	Human Body Model			
ESD	ElectroStatic Discharge			
MM	Machine Model			
DUT	Device Under Test			
TTL	Transistor-Transistor Logic			

15. Revision history

Table 13. Revision	history			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC1G74 v.12	20130402	Product data sheet	-	74LVC1G74 v.11
Modifications:	 For type nu 	mber 74LVC1G74GD XSO	N8U has changed to XS	SON8.
74LVC1G74 v.11	20120604	Product data sheet	-	74LVC1G74 v.10
Modifications:	 For type nu 	mber 74LVC1G74GM the S	OT code has changed	to SOT902-2.
74LVC1G74 v.10	20111202	Product data sheet	-	74LVC1G74 v.9
Modifications:	 Legal pages 	s updated.		
74LVC1G74 v.9	20100805	Product data sheet	-	74LVC1G74 v.8
74LVC1G74 v.8	20091203	Product data sheet	-	74LVC1G74 v.7
74LVC1G74 v.7	20080626	Product data sheet	-	74LVC1G74 v.6
74LVC1G74 v.6	20080219	Product data sheet	-	74LVC1G74 v.5
74LVC1G74 v.5	20070809	Product data sheet	-	74LVC1G74 v.4
74LVC1G74 v.4	20061207	Product data sheet	-	74LVC1G74 v.3
74LVC1G74 v.3	20050201	Product specification	-	74LVC1G74 v.2
74LVC1G74 v.2	20040909	Product specification	-	74LVC1G74 v.1
74LVC1G74 v.1	20040202	Product specification	-	-

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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